

Sipeed I2S_Mic Datasheet v1.0



Key Features:

- MEMS Microphone: MSM261S4030H0 is an omnidirectional, bottomported, I2S digital output MEMS microphone with excellent performance and reliability.
- Sensitivity: -26(dB, dBFS @1kHz 1Pa)
- Signal to noise ratio: 57dB (20kHz bandwidth, A-weighted)
- Size: 15.2*9.1mm
- Connecting method: 1*6P 2.54mm header

Sipeed Technology www.sipeed.com



| UPDATE | |
|--------|--------------------------------------|
| V1.0 | 2019/7/9 Published original document |
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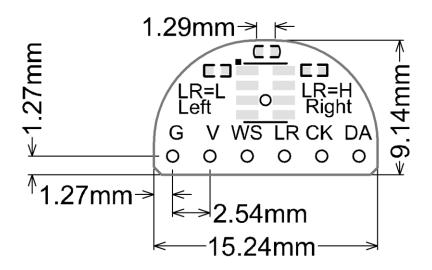
| | SPECIFICATION |
|---------------------------|--|
| MEMS MICs : MSM261S4030H0 | Sound Pressure Level : 140 dB SPL |
| | Sensitivity : -26(dB,dBFS @1kHz 1Pa) |
| | Signal to noise ratio : 57 dB (20kHz bandwidth,A-weighted) |
| | THD<1% (100dB SPL @1kHz S=Nom,Rload>2k) |
| | Clock frequency: |
| | 1.0-4.0Mhz(normal mode) |
| | 150-800khz(low power mode) |

| HARDWARE FEATURES | | |
|---|------------|--|
| Supply voltage of external power supply | 3.3V ±0.2V | |
| Supply current of external power supply | >1mA | |
| Temperature rise | <30K | |
| Range of working temperature | -30℃ ~ 85℃ | |

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| SIZE | | |
|--------|---------|--|
| Length | 15.24mm | |
| Width | 9.14mm | |
| Height | 11.2 mm | |



Sipeed Technology 2



| RESOURCES | | |
|----------------------------|------------------------------|--|
| Official Website | www.sipeed.com | |
| Github | https://github.com/Lichee-Pi | |
| BBS | http://bbs.sipeed.com | |
| Wiki | maixpy.sipeed.com | |
| Sipeed Model Store | https://maixhub.com/ | |
| SDK Reference | dl.sipeed.com/MAIX/SDK | |
| HDK Reference | dl.sipeed.com/MAIX/HDK | |
| E-mail (Technical Support) | support@sipeed.com | |
| Telegram Link | https://t.me/sipeed | |
| QQ Group | 878189804 | |



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